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# Features

- Six channels of EMI filtering with integrated ESD protection
- Pi-style EMI filters in a capacitor-resistorcapacitor (C-R-C) network
- ±15kV ESD protection on each channel (IEC 61000-4-2 Level 4, contact discharge)
- ±30kV ESD protection on each channel (HBM)
- Greater than -35dB attenuation (typical) at 1GHz
- 12-lead DFN package with 0.50mm lead pitch
- Tiny 3.0mm x 1.35mm DFN package size
- Increased robustness against vertical impacts during manufacturing process
- RoHS compliant, lead-free finishing

# Applications

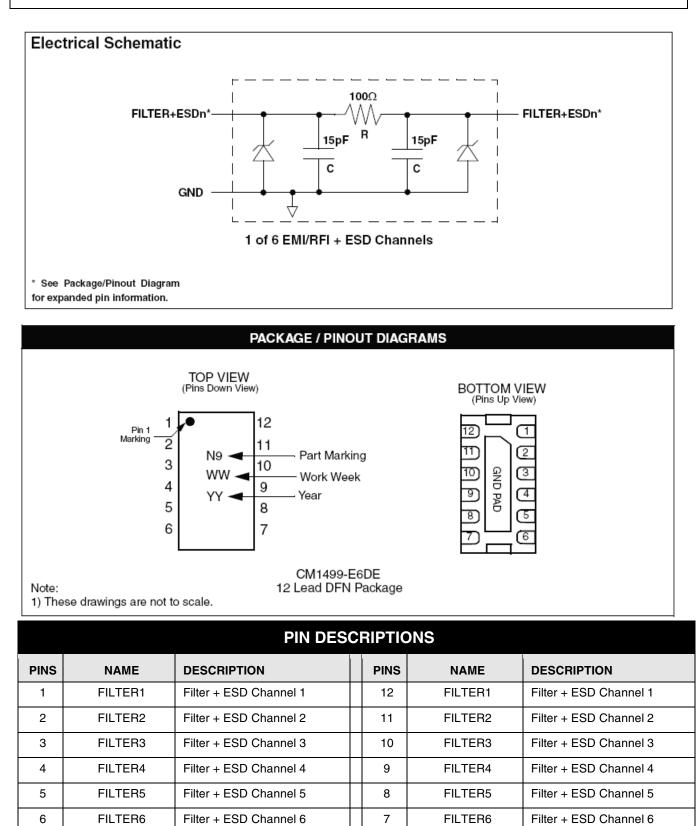
- LCD and Camera data lines in mobile handsets
- I/O port protection for mobile handsets, notebook computers, PDAs etc.
- EMI filtering for data ports in cell phones, PDAs or notebook computers.
- Wireless handsets
- Handheld PCs/PDAs
- LCD and camera modules

## **Product Description**

The CM1499-E6DE is a 6-channel pi-style EMI filter array with ESD protection that integrates six filters (C-R-C) into a small form factor 0.50mm pitch, DFN package. The CM1499-E6DE has component values of  $15pF-100\Omega-15pF$  per channel. The CM1499-E6DE provides a cut-off frequency of 110MHz and can be used in applications with data rates of up to 44Mbps. The parts include ESD diodes on every pin that provide a very high level of protection for sensitive electronic components against possible electrostatic discharge (ESD). The ESD protection diodes safely dissipate ESD strikes of ±15kV, which well beyond the maximum requirement of the IEC61000-4-2 international standard. In accordance with MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than ±30kV.

These devices are particularly well-suited for portable electronics (e.g. wireless handsets, PDAs, notebook computers) because of their small package and easy-to-use pin assignments. In particular, the CM1499-E6DE is ideal for EMI filtering and protecting data and control lines for the I/O data ports, LCD display and camera interface in mobile handsets.

The CM1499-E6DE is housed in a space-saving, low-profile 12-lead DFN package with a 0.50mm pitch with RoHS compliant lead-free finishing.



GND

GND PAD **Device Ground** 

# **Ordering Information**

PART NUMBERING INFORMATION							
		Lead-free Finish					
Pins	Package	Ordering Part Number <sup>1</sup>	Part Marking				
12	DFN-12	CM1499 -E6DE	N9				

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

# **Specifications**

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	RATING	UNITS				
Storage Temperature Range	-65 to +150	°C				
DC Power per Resistor	100	mW				
DC Package Power Rating	500	mW				

STANDARD OPERATING CONDITIONS						
PARAMETER	RATING	UNITS				
Operating Temperature Range	-40 to +85	°C				

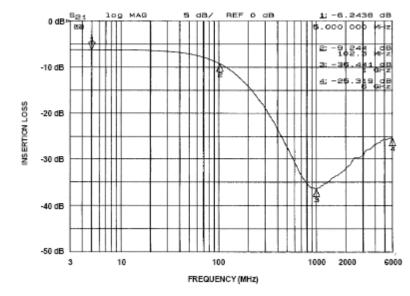
ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE1)										
SYMBOL	PARAMETER	CONDITIONS	MIN	ТҮР	МАХ	UNITS				
R	Resistance		85	100	115	Ω				
C <sub>TOTAL</sub>	Total Channel Capacitance	At 2.5VDC Reverse Bias, 1MHz, 30mVAC	24	30	36	pF				
С	Capacitance C <sub>1</sub>	At 2.5VDC Reverse Bias, 1MHz, 30mVAC		15		pF				
V <sub>DIODE</sub>	Standoff Voltage	I <sub>DIODE</sub> =1mA	6.0	7.0	8.0	V				
I <sub>LEAK</sub>	Diode Leakage Current (reverse bias)	V <sub>DIODE</sub> = +3.0V		0.1	1.0	mA				
V <sub>ESD</sub>	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-	Note 2	±30 ±15			kV kV				
	2 Level 4									
R <sub>DYN</sub>	Dynamic Resistance Positive Negative			2.3 0.9		W W				
f <sub>c</sub>	Cut-off Frequency $Z_{SOURCE}$ =50 $\Omega$ , $Z_{LOAD}$ =50 $\Omega$	Channel R = $100\Omega$ , Channel C = $15pF$		110		MHz				
A <sub>1GHz</sub>	Absolute Attenuation @ 1GHz from 0dB Level	$Z_{\text{SOURCE}} = 50\Omega$ , $Z_{\text{LOAD}} = 50\Omega$ , DC Bias = 0V; Notes 1 and 3		35		dB				
А <sub>800МНz</sub> - 6GHz	Absolute Attenuation @ 800MHz to 6GHz from 0dB Level	$Z_{\text{SOURCE}} = 50\Omega$ , $Z_{\text{LOAD}} = 50\Omega$ , DC Bias = 0V; Notes 1 and 3		30		dB				

Note 1:  $T_A=25^{\circ}C$  unless otherwise specified.

Note 2: ESD applied to input and output pins with respect to GND, one at a time.

Note 3: Attenuation / RF curves characterized by a network analyzer using microprobes.

## **Performance Information**



Typical EMI Filter Performance (T<sub>A</sub>=25°C, DC Bias=0V, 50 Ohm Environment)

Figure 1. Insertion Loss vs. Frequency (Filter 1 Input to GND)

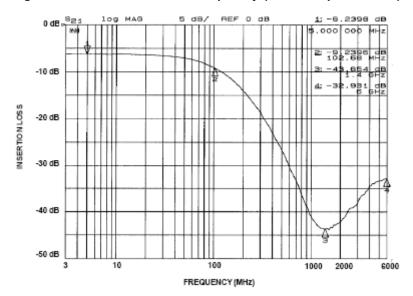


Figure 2. Insertion Loss vs. Frequency (Filter 2 Input to GND)

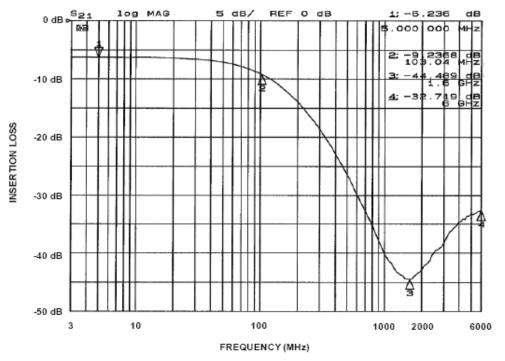


Figure 3. Insertion Loss vs. Frequency (Filter 3 Input to GND)

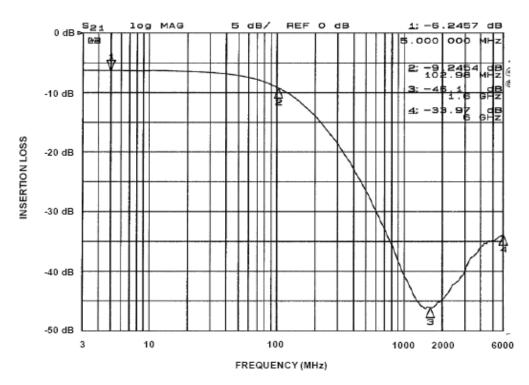
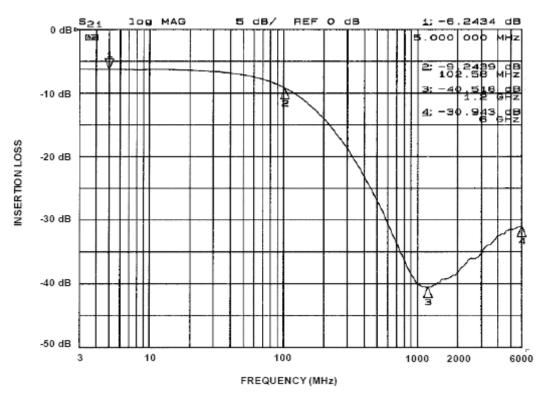


Figure 4. Insertion Loss vs. Frequency (Filter 4 Input to GND)





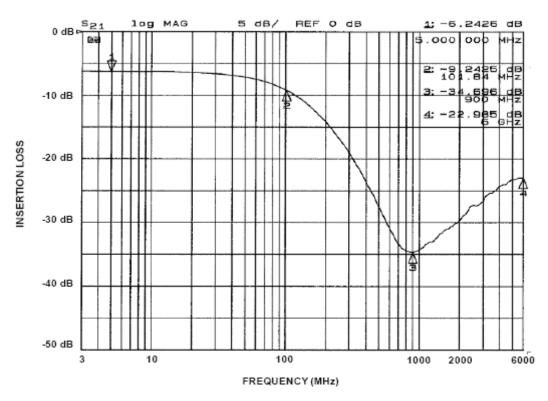
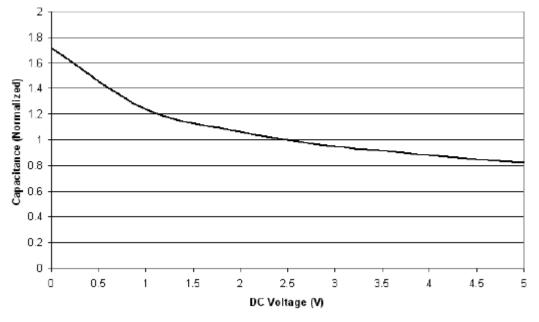
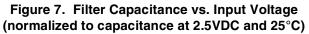


Figure 6. Insertion Loss vs. Frequency (Filter 6 Input to GND)

## Performance Information (cont'd)



Typical Diode Capacitance vs. Input Voltage



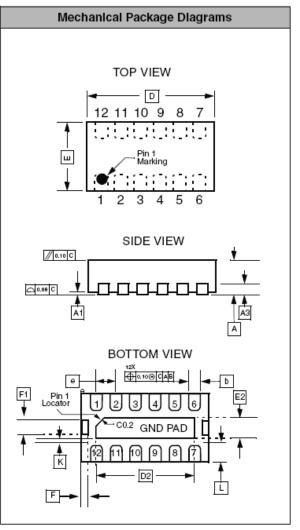
## **Mechanical Details**

#### **DFN-12 EEP Mechanical Specifications**, 0.5mm

The 12-lead, 0.5mm pitch DFN package dimensions with Exposed End Pads (EEP) are presented below.

PACKAGE DIMENSIONS								
Package	DFN							
JEDEC No.	MO-229C*							
Leads			1	2				
Dim.	Millimeters				Inches			
	Min	Nom	Мах	Min	Nom	Max		
А	0.80	0.90	1.00	0.031	0.035 0.039			
A1	0.00	0.02	0.05	0.000	0.000 0.001 0.002			
A3	(	0.20 RE	F	0.008 REF				
b	0.20	0.25	0.30	0.008	0.010 0.01			
D	2.90	3.00	3.10	0.114	0.118	0.122		
D2	2.10	2.20	2.30	0.083	0.087	0.091		
E	1.30	1.35	1.40	0.051	051 0.053 0.0			
E2	0.25	0.30	0.35	0.010	0.010 0.012 0.014			
е		0.50 BS	С	0.020 BSC				
F		0.20 REF			0.008 REF			
F1		0.25 REF			0.010 REF			
к	0.28 REF			0.011 REF				
L	0.20	0.25	0.30	0.008	0.010	0.012		
# per tape and reel	3000 pieces							
Controlling dimension: millimeters								

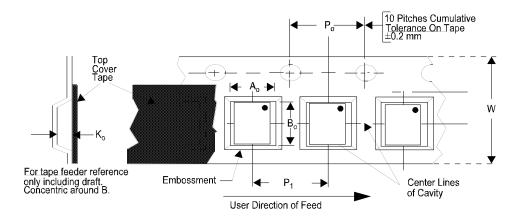
<sup>\*</sup>This package is compliant with JEDEC standard MO-229C with the exception of the D, D2, E, E2, K and L dimensions as called out in the table above.



Dimensions for 12-Lead, 0.5mm pitch DFN package with Exposed End Pads (EEP)

#### Tape and Reel Specifications

PART NUMBER	PACKAGE SIZE (mm)	POCKET SIZE (mm) B <sub>0</sub> X A <sub>0</sub> X K <sub>0</sub>	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P₀	P <sub>1</sub>
CM1499 -E6DE	1.35 X 3.00 X 0.90	1.60 X 3.35 X 1.10	8mm	178mm (7")	3000	4mm	4mm



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